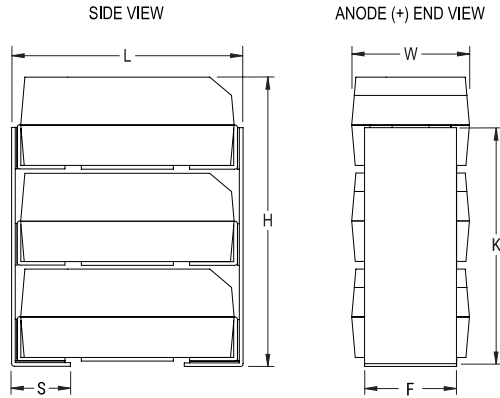


TSP, Tantalum, Polymer Tantalum, HRA, 99 uF, 20%, 10 VDC, 3B



Dimensions	
Case Code	3B
L	4.1mm +/-0.38mm
W	3.1mm +/-0.2mm
H	6.3mm +/-0.38mm
S	0.76mm +/-0.38mm
F	2.3mm +/-0.2mm
K	5.3mm +/-0.38mm

Packaging Specifications	
Packaging:	Tray
Packaging Quantity:	50

General Information	
Series:	TSP
Dielectric:	Polymer Tantalum
Style:	Stacked Chip
Description:	SMD, Polymer, KO, Stacks, High Reliability
Features:	High Reliability
RoHS:	No
Prop 65:	WARNING: Cancer and reproductive harm - www.p65warnings.ca.gov .
SCIP Number:	30e82d35-b509-48ec-8c77-2d5ec01b3abc
Termination:	Solder Coated
Termination (Stack):	Silver Plated
AEC-Q200:	No
MSL:	3

Specifications	
Capacitance:	99 uF
Capacitance Tolerance:	20%
Voltage DC:	10 VDC (105C), 6.7 VDC (125C)
Temperature Range:	-55/+125°C
Rated Temperature:	105°C
Dissipation Factor:	8% 120Hz 25C
Failure Rate:	N/A
Resistance:	27 mOhms (100kHz 25C)
Leakage Current:	99 uA (5min 25°C)
Testing and Reliability:	4 Cycles At +25C +/-5C

单击下面可查看定价，库存，交付和生命周期等信息

[>>KEMET\(基美\)](#)